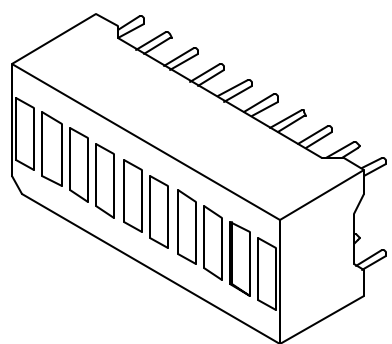
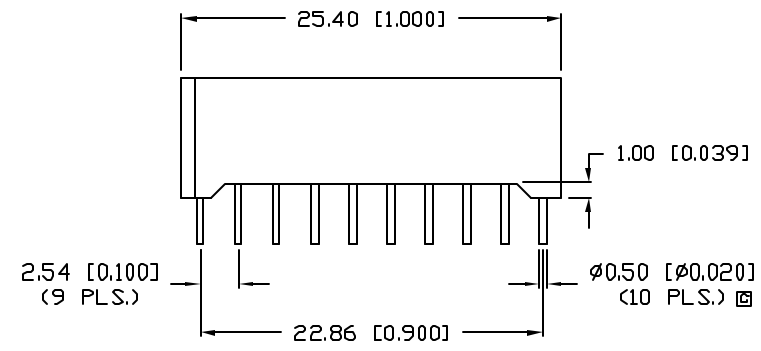
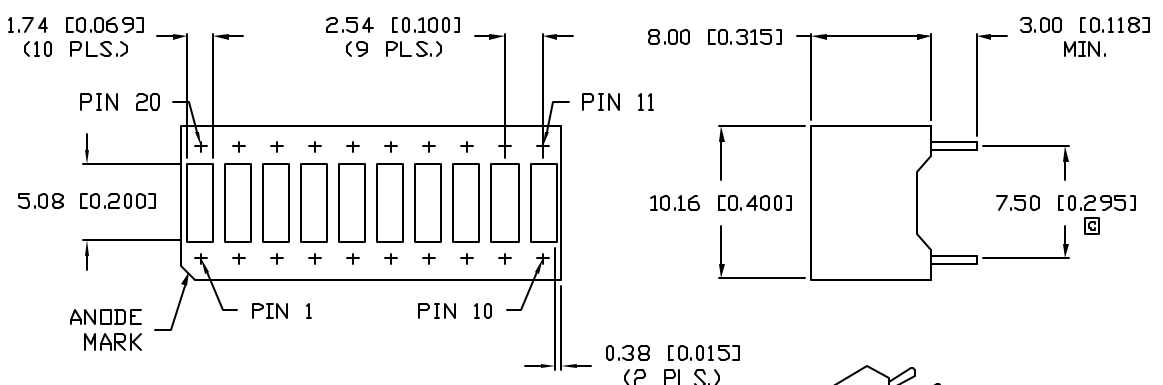
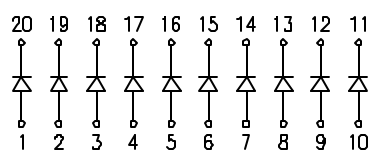


UNCONTROLLED DOCUMENT

SC:0.50	PART NUMBER	REV.
	SSA-LXB10GW	E
REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	CHG'D SAVE OPER SPECS.	6.7.94
B	CHG'D SAVE OPER SPECS.	8.29.94
C	E.C.N. #10477. & #10BRDR. & REDRAWN.	5.12.99
D	E.C.N. #10BRDR. & REDRAWN.	7.2.01
E	E.C.N. #11148	5.22.07



TOP VIEW POLARITY



UNDER REVISION

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		2.2	2.6	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		8		mcad	$I_f=20\text{mA}$
VIEWING ANGLE		160		2x theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	MILKY WHITE DIFFUSED				
FACE COLOR:	BLACK				

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= ^{+DECIMAL PRECISION} -0.00 ^{MAX.= +0.00} -DECIMAL PRECISION

REV.	PART NUMBER
E	SSA-LXB10GW

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10 SEGMENT RECTANGULAR BAR GRAPH,
 GREEN CHIPS, MILKY WHITE DIFFUSED.

RELIABILITY NOTE
 OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:	CHECKED BY:	APPROVED BY:	DATE: 10.14.93
JN			PAGE: 1 OF 1
			SCALE: N/A

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